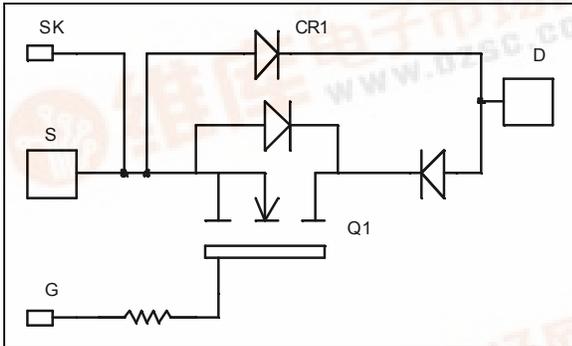




# APT0502

*Single switch  
Series & parallel diodes  
MOSFET Power Module*

$V_{DSS} = 1000V$   
 $R_{DSon} = 65m\Omega \text{ typ @ } T_j = 25^\circ C$   
 $I_D = 145A \text{ @ } T_c = 25^\circ C$

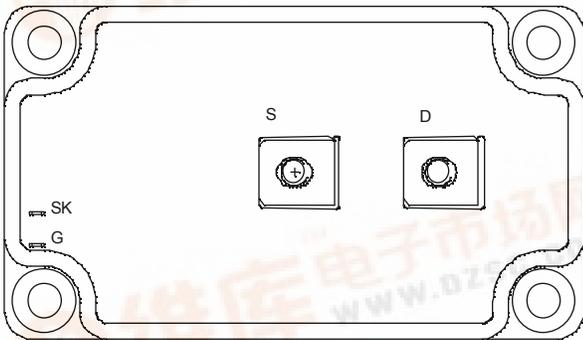


**Application**

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

**Features**

- Power MOS 7<sup>®</sup> MOSFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration
- AlN substrate for improved thermal performance



**Benefits**

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile
- RoHS Compliant

**Absolute maximum ratings**

Symbol	Parameter	Max ratings	Unit
$V_{DSS}$	Drain - Source Breakdown Voltage	1000	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	145
		$T_c = 80^\circ C$	110
$I_{DM}$	Pulsed Drain current	580	A
$V_{GS}$	Gate - Source Voltage	$\pm 30$	V
$R_{DSon}$	Drain - Source ON Resistance	78	$m\Omega$
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	3250
$I_{AR}$	Avalanche current (repetitive and non repetitive)	30	A
$E_{AR}$	Repetitive Avalanche Energy	50	mJ
$E_{AS}$	Single Pulse Avalanche Energy	3200	

**CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 1000V	T <sub>j</sub> = 25°C			400	μA
		V <sub>GS</sub> = 0V, V <sub>DS</sub> = 800V	T <sub>j</sub> = 125°C			2	mA
R <sub>DS(on)</sub>	Drain – Source on Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 72.5A			65	78	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 20mA		3		5	V
I <sub>CSS</sub>	Gate – Source Leakage Current	V <sub>GS</sub> = ±30 V, V <sub>DS</sub> = 0V				±400	nA

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> = 0V		28.5		nF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 25V		5.08		
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		0.9		
Q <sub>g</sub>	Total gate Charge	V <sub>GS</sub> = 10V V <sub>Bus</sub> = 500V I <sub>D</sub> = 145A		1068		nC
Q <sub>gs</sub>	Gate – Source Charge			136		
Q <sub>gd</sub>	Gate – Drain Charge			692		
T <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> = 15V V <sub>Bus</sub> = 500V I <sub>D</sub> = 145A R <sub>G</sub> = 0.75Ω		18		ns
T <sub>r</sub>	Rise Time			14		
T <sub>d(off)</sub>	Turn-off Delay Time			140		
T <sub>f</sub>	Fall Time			55		
E <sub>on</sub>	Turn-on Switching Energy	<b>Inductive switching @ 25°C</b> V <sub>GS</sub> = 15V, V <sub>Bus</sub> = 670V I <sub>D</sub> = 145A, R <sub>G</sub> = 0.75Ω		4.8		mJ
E <sub>off</sub>	Turn-off Switching Energy			2.9		
E <sub>on</sub>	Turn-on Switching Energy	<b>Inductive switching @ 125°C</b> V <sub>GS</sub> = 15V, V <sub>Bus</sub> = 670V I <sub>D</sub> = 145A, R <sub>G</sub> = 0.75Ω		8		mJ
E <sub>off</sub>	Turn-off Switching Energy			3.9		

**Series diode ratings and characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit	
V <sub>RRM</sub>	Maximum Peak Repetitive Reverse Voltage		200			V	
I <sub>RM</sub>	Maximum Reverse Leakage Current	V <sub>R</sub> = 200V	T <sub>j</sub> = 25°C			350	μA
			T <sub>j</sub> = 125°C			600	
I <sub>F</sub>	DC Forward Current			120		A	
V <sub>F</sub>	Diode Forward Voltage	I <sub>F</sub> = 120A			1.1	1.15	V
		I <sub>F</sub> = 240A			1.4		
		I <sub>F</sub> = 120A	T <sub>j</sub> = 125°C		0.9		
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 120A V <sub>R</sub> = 133V di/dt = 400A/μs	T <sub>j</sub> = 25°C		31		ns
			T <sub>j</sub> = 125°C		60		
Q <sub>rr</sub>	Reverse Recovery Charge		T <sub>j</sub> = 25°C		120		nC
			T <sub>j</sub> = 125°C		500		

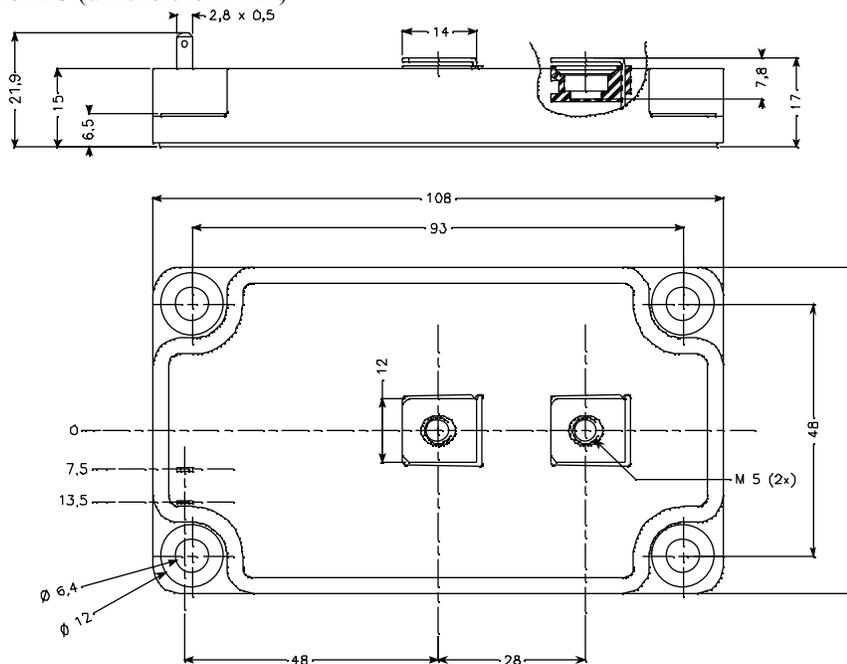
## Parallel diode ratings and characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage		1000			V
$I_{RM}$	Maximum Reverse Leakage Current	$V_R=1000V$	$T_j = 25^\circ C$		750	$\mu A$
			$T_j = 125^\circ C$		1000	
$I_F$	DC Forward Current	$T_c = 80^\circ C$		240		A
$V_F$	Diode Forward Voltage	$I_F = 240A$		2	2.5	V
		$I_F = 480A$		2.2		
		$I_F = 240A$	$T_j = 125^\circ C$	1.7		
$t_{rr}$	Reverse Recovery Time	$I_F = 240A$ $V_R = 667V$ $di/dt = 800A/\mu s$	$T_j = 25^\circ C$	280		ns
			$T_j = 125^\circ C$	350		
$Q_{rr}$	Reverse Recovery Charge	$I_F = 240A$ $V_R = 667V$ $di/dt = 800A/\mu s$	$T_j = 25^\circ C$	3.04		$\mu C$
			$T_j = 125^\circ C$	14.4		

## Thermal and package characteristics

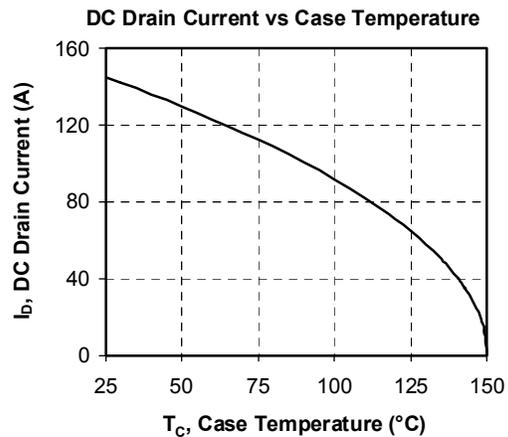
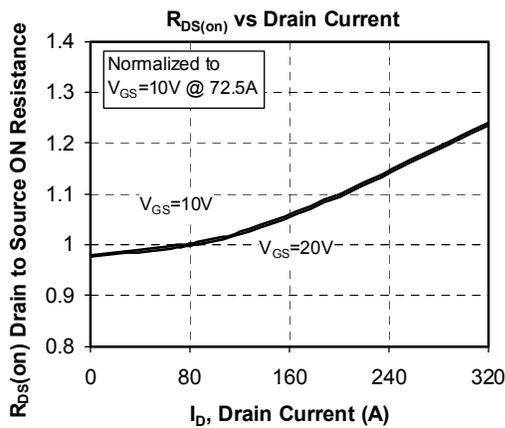
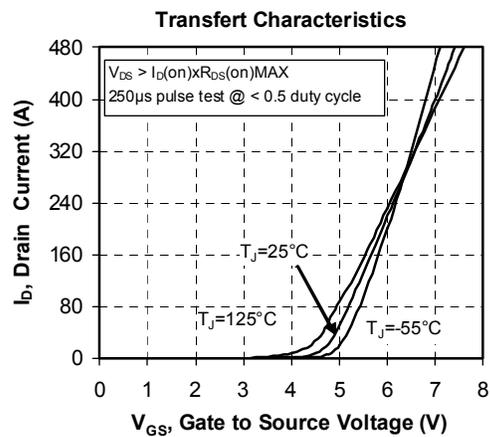
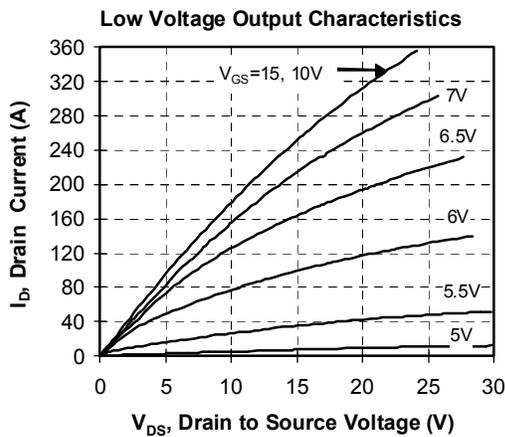
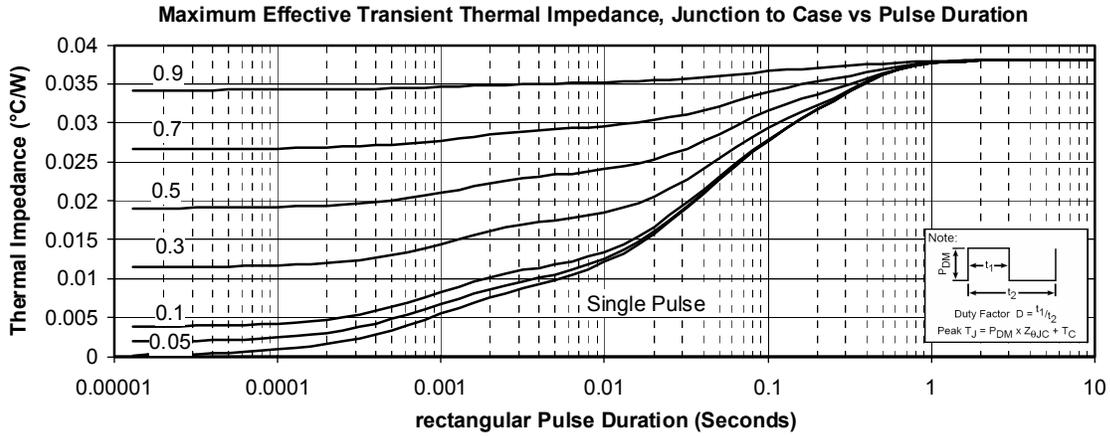
Symbol	Characteristic	Min	Typ	Max	Unit	
$R_{thJC}$	Junction to Case Thermal Resistance	Transistor		0.038	$^\circ C/W$	
		Series diode		0.46		
		Parallel diode		0.23		
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case $t=1$ min, $I_{sol}<1mA$ , 50/60Hz	2500			V	
$T_J$	Operating junction temperature range	-40		150	$^\circ C$	
$T_{STG}$	Storage Temperature Range	-40		125		
$T_C$	Operating Case Temperature	-40		100		
Torque	Mounting torque	To Heatsink	M6	3	5	N.m
		For terminals	M5	2	3.5	
Wt	Package Weight			280	g	

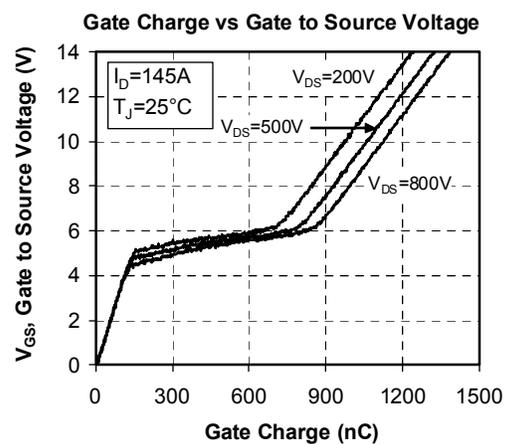
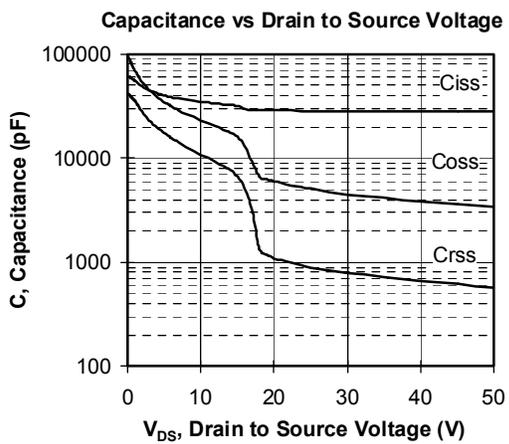
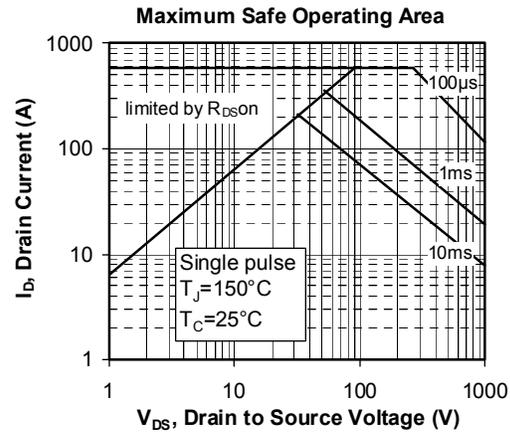
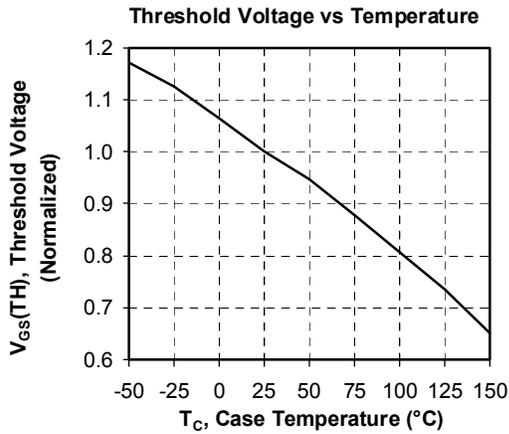
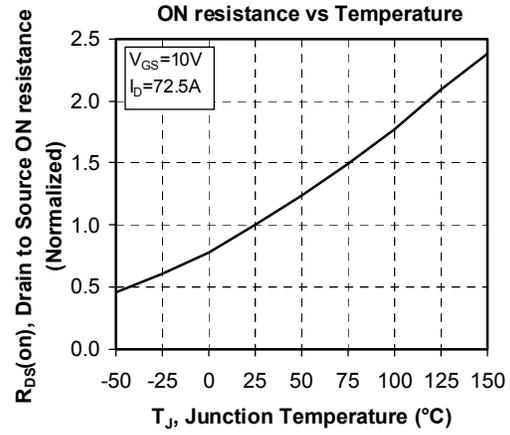
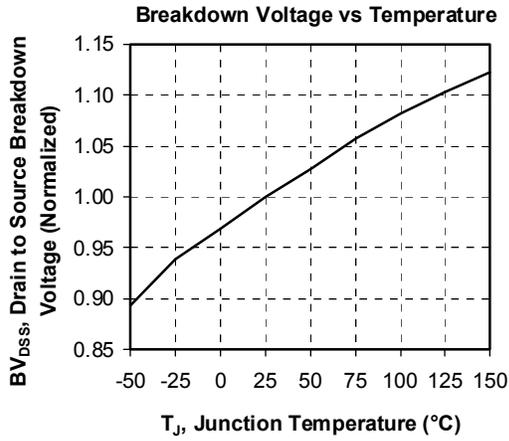
## SP6 Package outline (dimensions in mm)

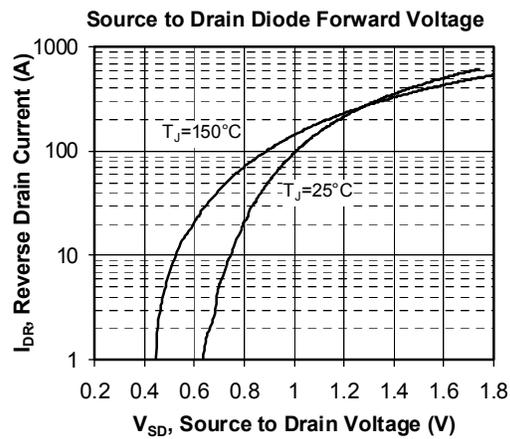
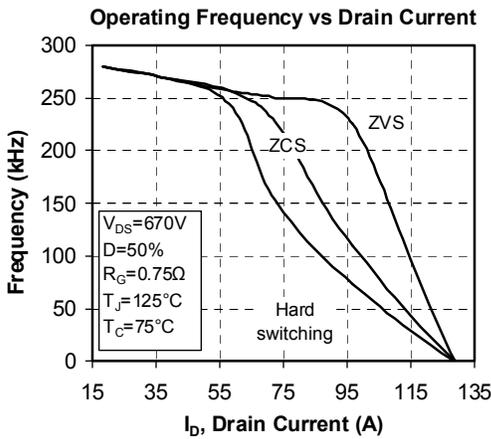
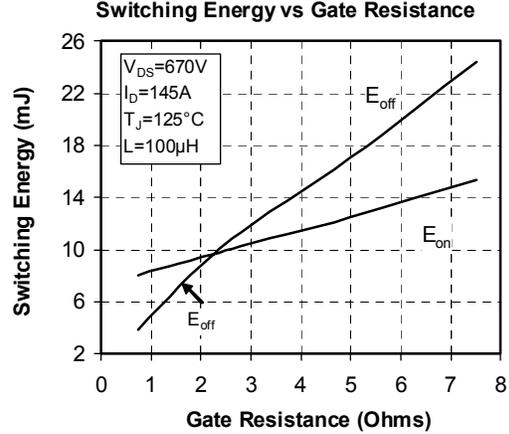
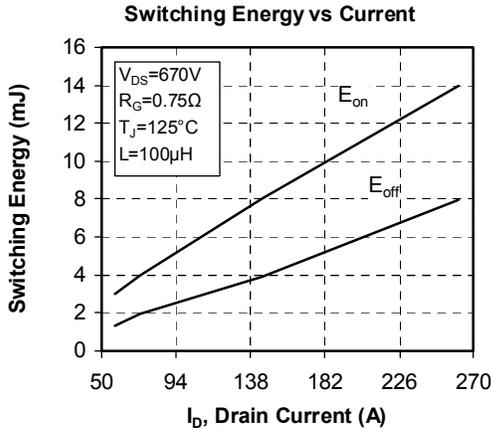
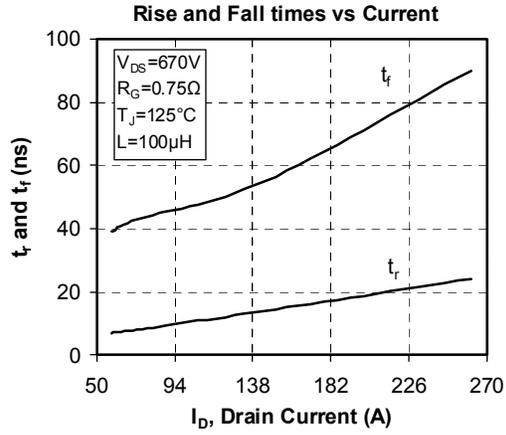
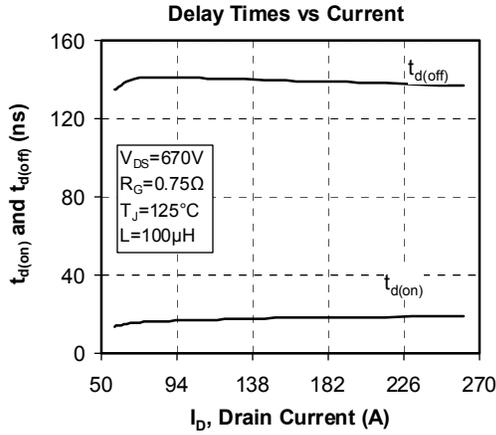


See application note APT0601 - Mounting Instructions for SP6 Power Modules on [www.microsemi.com](http://www.microsemi.com)

## Typical Performance Curve







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